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#### **KLT-E6K-IMX214 V2.0**

### 13MP Sony IMX214 MIPI Interface M12 Fixed Focus Camera Module







**Back View** 

#### **Specifications**

Camera Module No.Tech.com	WKLT-E6K-IMX214 V270 Ch
Resolution	13MP
Image Sensor	IMX214
Sensor Type	1/3.06"
Pixel Size	1.12 um x 1.12 um
EFL	2.27 mm
F.NO	2.40
Pixel	4224 x 3136
View Angle	152.0°(DFOV) 122.0°(HFOV) 93.0°(VFOV)
Lens Dimensions Tech com	13:00\x/13:00\x 22-82\mmch COm
Module Size	60.00 x 22.00 mm
Module Type	Fixed Focus
Interface	MIPI
Auto Focus VCM Driver IC	None
Lens Model	KLT-LENS-YM6081
Lens Type	650nm IR Cut
Operating Temperature	-20°C to +70°C
Mating Connector	DF30FC-30DS-0.4V





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# KLT-E6K-IMX214 V2.0 13MP Sony IMX214 MIPI Interface M12 Fixed Focus Camera Module



Top View

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**Bottom View** 

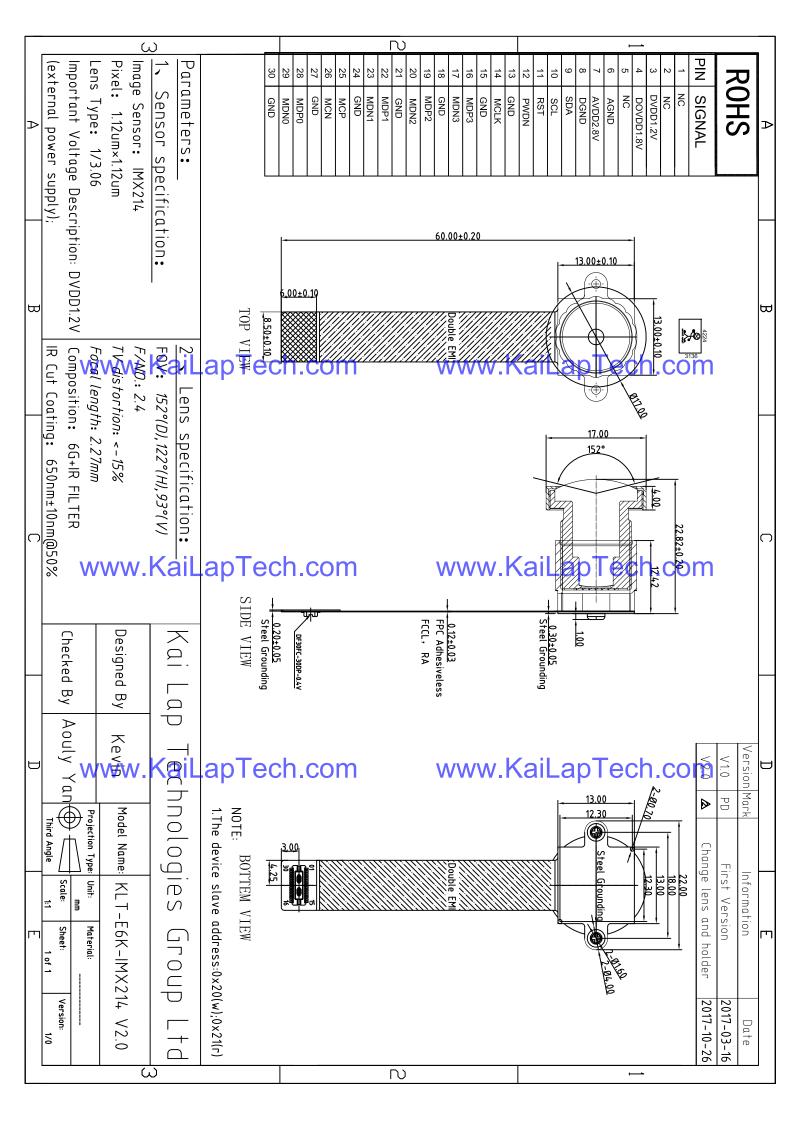


Side View

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**Mating Connector** 

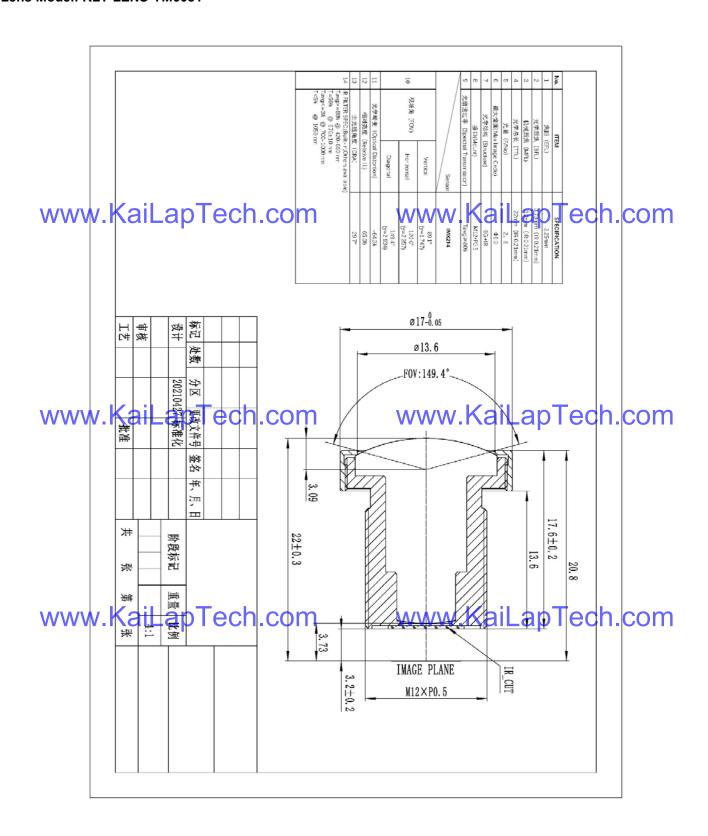






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Lens Model: KLT-LENS-YM6081



### 0.4 mm Pitch, 0.9 mm Height, Board-to-Board / Board-to-FPC Connectors

#### **DF30 Series**





#### Overview

Continuous miniaturization and increased component density on PCB created demand for extremely low profile connectors. This series is addition of a new extremely low profile connectors to Hirose's wide range of high reliability board-to-board/board-to-FPC connection solutions.

#### Features

### 1. Contact reliability plech.com

Concentration of the contact's normal forces at the single point assures good contact wipe and electrical reliability, while confirming the fully mated condition with a definite tactile click.

#### 2. Self alignment

Recognizing the difficulties of mating extremely small connectors in limited spaces the connectors will self align in horizontal axis within 0.3 mm.

#### 3. Automatic board placement

Packaged on tape-and-reel the plug and headers have sufficiently large flat areas to allow pick-up with vacuum nozzles of automatic placement equipment.

#### 4. Variety of contact positions and styles

Available in standard contact positions of: 20, 22, 24, 30, 34, 40, 50, 60, 70 and 80 with and without metal fittings. Addition of metal fittings does not affect external dimensionsof the connectors.

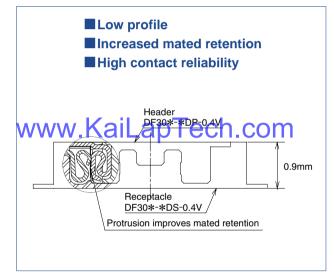
Smaller contact positions are also available.

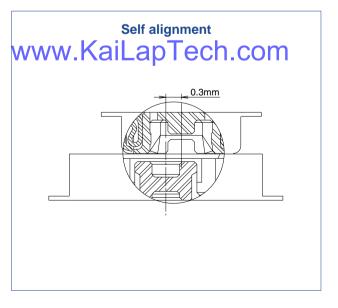
#### 5. Support for continuity test connector

Connectors which have increased insertion and removal durability are available for continuity tests. Contact your Hirose sales representative for details.

#### Applications

Cellular phones, PDA's, mobile computers, digital cameras, digital video cameras, and other devices demanding high reliability connections in extremely limited spaces.





#### **■**Product Specifications

Detien	Rated current 0.3A	Operating temperature range	: -35°C to 85°C (Note 1)	Storage temperature range	e -10°C to 60°C (Note 2)
Rating	Rated voltage 30V AC	Operating humidity range	: Relative humidity 20% to 80%	Storage humidity range	Relative humidity 40% to 70% (Note 2)

Item	Specification	Conditions
1. Insulation resistance	50 MΩ min.	100V DC
2. Withstanding voltage	No flashover or insulation breakdown.	100V AC / one minute
3. Contact resistance	100 mΩ max.	100 mA
4. Vibration	No electrical discontinuity of 1 $\mu$ s or more	Frequency: 10 to 55 Hz, single amplitude of 0.75mm, 2 hours, 3 axis
5. Humidity	Contact resistance: 100 m $\Omega$ max. Insulation resistance: 25 M $\Omega$ min.	96 hours at temperature of $40$ °C±2°C and RH of 90% to 95%
6. Temperature cycle	Contact resistance: $100 \text{ m}\Omega$ max. Insulation resistance: $50 \text{ M}\Omega$ min.	Temperature: $-55^{\circ}$ C $\rightarrow +5^{\circ}$ C to $+35^{\circ}$ C $\rightarrow +85^{\circ}$ C $\rightarrow +5^{\circ}$ C to $+35^{\circ}$ C Duration: $30 \rightarrow 10 \rightarrow 30 \rightarrow 10$ (Minutes) 5 cycles
7. Durability (insertions/withdrawals)	Contact resistance: 100 mp max.	86 bydes (Connector for Conductivity ests 500 dycles)
8. Resistance to soldering heat	No deformation of components affecting performance.	Reflow: At the recommended temperature profile Manual soldering: 300°C for 3 seconds

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating temperature range and humidity range covers non-conducting condition of installed connectors in storage, shipment or during transportation.

#### **■**Materials and Finishes

Connectors	Component	Material	Finish	Remarks
WReceptacles 3	an Insulation CC	m LCP V	VVVVColor : Black an	echul94vm
and	Contacts	Phosphor bronze	Gold plated	<u> </u>
Headers	Metal fittings	Phosphor bronze	Tin-cupper plated	

### **■**Ordering information

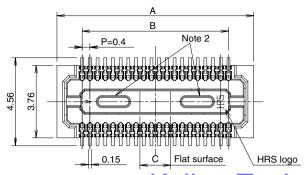
Receptacles and Headers

# 

6 Contact pitch: 0.4 mm	
6 Termination section	
V: Straight SMT	
Packaging	
(81): Embossed tape packaging (5,000 pieces per reel)	
(82): Embossed tape packaging (1,000 pieces per reel)	

### ■Receptacles (without metal fittings)

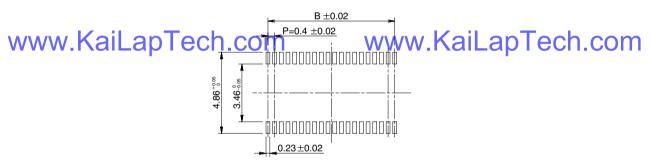




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### 



Recommended solder paste thickness: 120  $\mu m$ 

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[Specification number] -\*\*, (\*\*)

(81): Embossed tape packaging (5 000 pieces per reel)

\* Tolerances non- accumulative

Unit: mm

Tolerances non accumulative.					O11111. 111111
Part Number	CL No.	Number of contacts	Α	В	С
DF30FC-20DS-0.4V(**)	CL684-1109-8-**	20	6.22	3.6	1.2
DF30FC-22DS-0.4V(**)	CL684-1110-7-**	22	6.62	4.0	1.2
DF30FC-24DS-0.4V(**)	CL684-1111-0-**	24	7.02	4.4	1.2
DF30FC-30DS-0.4V(**)	CL684-1112-2-**	30	8.22	5.6	1.2
DF30FC-34DS-0.4V(**)	CL684-1113-5-**	34	9.02	6.4	1.36
DF30FC-40DS-0.4V(**)	CL684-1078-6-**	40	10.22	7.6	1.6
DF30FC-50DS-0.4V(**)	CL684-1114-8-**	50	12.22	9.6	2.0
DF30FC-60DS-0.4V(**)	CL684-1082-3-**	60	14.22	11.6	2.4
DF30FC-70DS-0.4V(**)	CL684-1115-0-**	70	16.22	13.6	2.8
DF30FC-80DS-0.4V(**)	CL684-1116-3-**	80	18.22	15.6	3.2

Note 1: Order by number of reels.

Note 2: Receptacles with 24 or fewer contacts positions will not have recessed areas.

### SONY

### [Product Brief]

Ver.1.0

**IMX214** 

Diagonal 5.867mm (Type 1/3.06) 13M Pixel CMOS Image Sensor with Square Pixel for Color Cameras

#### **Description**

IMX214 is a diagonal 5.867mm(Type 1/3.06) 13M pixel CMOS active pixel type stacked image sensor with a square pixel array. It adopts Exmor RS™ technology to achieve high speed image capturing by column parallel A/D converter circuits and high sensitivity and low noise image (comparing with conventional CMOS image sensor) through the backside illuminated imaging pixel structure. R, G, and B pigment primary color mosaic filter is employed. Wby introducing spacially varying exposure technology, high dynamic/ange still pictures and movies are achievable. It equips an electronic shutter with variable integration time. It operates with three power supply voltages: analog 2.7 V, digital 1.0V and 1.8 V for input/output interface and achieves low power consumption. IMX214 is designed for use in cellular phones or tablet devices\*.

#### **Functions and Features**

- ◆ Back illuminated and stacked CMOS image sensor Exmor RS
- ◆ Single Frame High Dynamic Range (HDR) with equivalent full pixels.
- ◆ High signal to noise ratio (SNR).

#### W// Full resolution @30fps (Nornmal / HDR) 4K2K @30fps (Normal / HDR) 1080p @60fps (Normal / HDR)

- Output video format of RAW10/8, COMP8/6
- ◆ Pixel binning readout and H/V sub sampling function
- ◆ Advanced Noise Reduction (Chroma noise reduction and luminance noise reduction)
- Independent flipping and mirroring.
- ◆ CSI 2 serial data output (MIPI 2lane/4lane, Max. 1.2Gbps/lane, DPHY spec. ver. 1.1 compliant)
- ◆ 2wire serial communication
- ◆ Two PLLs for independent clock generation for pixel control and data output interface.
- ◆ Advanced Noise Reduction.
- ◆ Dynamic Defect Pixel Correction.

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- ◆ Power on reset function
- Dual sensor synchronization operation.
- ♦ 8K bit of OTP ROM for users.
- Built in temperature sensor

#### NOTE)

1. When using this product for another application, Sony does not guarantee the quality and reliability of product. Therefore, don't use this for applications other than cellular phone and Tablet PCs. Consult your Sony sales representative if you have any questions.

SONY IMX214

#### **Device Structure**

◆ CMOS image sensor

♦ Image size : Diagonal 5.867mm (Type 1/3.06)

◆ Total number of pixels
 ♦ Number of effective pixels
 ♦ Number of active pixels
 14224 (H) ×3200(V) approx. 13.51M pixels
 14224 (H) ×3136 (V)approx. 13.25 M pixels
 14208 (H) ×3120 (V) approx. 13.13 M pixels

 ◆ Chip size
 : 6.100mm (H) × 4.524mm (V)

 ◆ Unit cell size
 : 1.12 μm (H) × 1.12 μm (V)

◆ Substrate material : Silicon

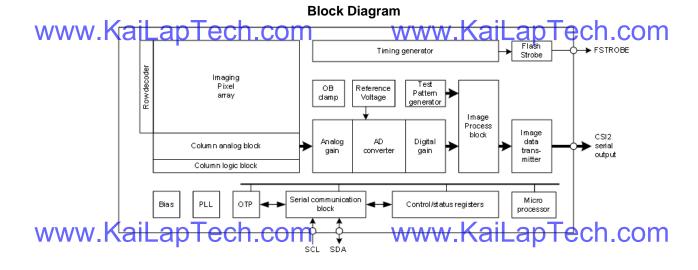
#### **Functional Description**

### system votal Kailap Tech.com www.Kailap Tech.com

IMX214 is a CMOS active pixel type image sensor which adopts the Exmor RS <sup>™</sup> technology to achieve high sensitivity, low noise and high speed image capturing. It is embedded with backside illuminated imaging pixel, low noise analog amplifier,

column parallel A/D converters which enables high speed capturing, digital amplifier, image binning circuit, timing control circuit for imaging size and frame rate, CSI2 image data high speed serial interface, PLL oscillator, and serial communication interface to control these functions.

Several additional image processing functions and peripheral circuits are also included for easy system optimization by the users. A one time programmable memory is embedded in the chip for storing the user data. It has 8 K-bit for users, 10 K-bit as a whole.



### Exmor**RS**

\* Exmor RS is a trademark of Sony Corporation. The Exmor RS is a Sony's CMOS image sensor with high-resolution, high-performance and compact size by replacing a supporting substrate in Exmor R™ which changed fundamental structure of Exmor™ pixel adopted column parallel A/D converter to back-illuminated type, with layered chips formed signal processing circuits.

Sony reserves the right to change products and specifications without prior notice.

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Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits.





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#### **Camera Module Pinout Definition Reference Chart**

	ina Himax GalaxyCore PixArt SmartSens Sensors
Pin Signal	Description
DGND GND	ground for digital circuit
AGND	ground for analog circuit
PCLK DCK	DVP PCLK output
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor
MCLK XVCLK XCLK INCK	system input clock
RESET RST	reset active low with internal pull-up resistor
NC NULL	no connect
SDA SIO_D SIOD	SCCB data
SCL SIO_C SIOC	SCCB input clock
VSYNC XVS FSYNC	DVP VSYNC output
MREAVXHX aiLap Lech.com	DVP HREF OUTPUTW. Kallap ech.com
DOVDD	power for I/O circuit
AFVDD	power for VCM circuit
AVDD	power for analog circuit
DVDD	power for digital circuit
STROBE FSTROBE	strobe output
FSIN	synchronize the VSYNC signal from the other sensor
SID	SCCB last bit ID input
ILPWM	mechanical shutter output indicator
FREX	frame exposure / mechanical shutter
GPIO	general purpose inputs
SLASEL	I2C slave address select
APPAW.KaiLap Lech.com	CEN chip enable active high on CM driver Q . CON
MIPI Interface	•
MDN0 DN0 MD0N DATA_N DMO1N	MIPI 1st data lane negative output
MDP0 DP0 MD0P DATA_P DMO1P	MIPI 1st data lane positive output
MDN1 DN1 MD1N DATA2_N DMO2N	MIPI 2nd data lane negative output
MDP1 DP1 MD1P DATA2_P DMO2P	MIPI 2nd data lane positive output
MDN2 DN2 MD2N DATA3_N DMO3N	MIPI 3rd data lane negative output
MDP2 DP2 MD2P DATA3_P DMO3P	MIPI 3rd data lane positive output
MDN3 DN3 MD3N DATA4_N DMO4N	MIPI 4th data lane negative output
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output
MCN CLKN CLK_N DCKN	MIPI clock negative output
MCP CLKP MCP CLK P DCKN	MIPI clock positive output
DVP/Parallel interface   CCII.COIII	www.KaiLapTech.con
D0 DO0 Y0	DVP data output port 0
D1 D01 Y1	DVP data output port 1
D2 DO2 Y2	DVP data output port 2
D3 DO3 Y3	DVP data output port 3
D4 DO4 Y4	DVP data output port 4
D5 DO5 Y5	DVP data output port 5
D6 DO6 Y6	DVP data output port 6
D7 D07 Y7	DVP data output port 7
D8 DO8 Y8	DVP data output port 8
D9 DO9 Y9	DVP data output port 9
D10 DO10 Y10	DVP data output port 10
D11 D011 Y11	DVP data output port 11





**Cameras Applications** 

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#### **Camera Reliability Test**

Reliability Inspection Item			Tanting Mathad	A coentaine Criteria	
Category		Item	Testing Method	Acceptance Criteria	
	Storage	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation	
	Temperature	Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation	
	Operation	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation	
Environmental	Temperature	Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation	
Environmental	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation	
www.	KaiLapTe Thermal Shock	High 60°C 0.5 Hours Low -20°C 0.5 Hours	www.KaiLap	Tech.com  No Abnormal Situation	
	Thermal Check	Cycling in 24 Hours	Tomporatare Griamoor	Tre Albridania Gradulari	
	Drop Test	Without Package 60cm	10 Times on Wood Floor	Electrically Functional	
	(Free Falling)	With Package 60cm	10 Times on Wood Floor	Electrically Functional	
		50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional	
Physical	Vibration Test	50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional	
	l/oil on To	50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional	
WWW.	Cable Tensile Strength Test  Cable Tensile Strength Test  Cable Tensile Cycling in 24 Hours		Tensile Testing Machine	Electrically Functional	
	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional	
Electrical	ESD Test	Air Discharge 4 KV	ESD Testing Machine	Electrically Functional	
	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional	
WWW.	USB Connector	On/Off 250 Times	W Plug and Unplugap	Electrically Functional	













#### **Camera Inspection Standard**

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Inspection Item Category		n Item		Standard of Inspection	
		Item	Inspection Method		
		Color	The Naked Eye	Major Difference is Not Allowed.	
	FPC/ PCB	Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.	
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)	
		Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed	
	Haldan	Gap	The Naked Eye	Meet the Height Standard	
Appearance	Holder	Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)	
WW	w.KaiL	ap Temp.con	↑ The Naked <b>Fye</b> //\	The Inside Crack Exposure is Not Allowed	
		Scratch	The Naked Eye	No Effect On Resolution Standard	
	Lens	Contamination	The Naked Eye	No Effect On Resolution Standard	
	Lens	Oil Film	The Naked Eye	No Effect On Resolution Standard	
		Cover Tape	The Naked Eye	No Issue On Appearance.	
		No Communication	Test Board	Not Allowed	
	w.KaiL Image	Bright Pixel	Black Board	Not Allowed In the Image Center	
14040		Dark Pixel	White board	Not Allowed In the Image Center	
VVVV		ap recn.com	The Naked Eye	Not Allowed ap Lech.com	
		No Image	The Naked Eye	Not Allowed	
		Vertical Line	The Naked Eye	Not Allowed	
		Horizontal Line	The Naked Eye	Not Allowed	
Function		Light Leakage	The Naked Eye	Not Allowed	
		Blinking Image	The Naked Eye	Not Allowed	
		Bruise	Inspection Jig	Not Allowed	
WW	w.KaiL	ap Resolution con	Chart WW\	Follows Outgoing Inspection Chart Standard	
		Color	The Naked Eye	No Issue	
		Noise	The Naked Eye	Not Allowed	
		Corner Dark	The Naked Eye	Less Than 100px By 100px	
		Color Resolution	The Naked Eye	No Issue	
		Height	The Naked Eye	Follows Approval Data Sheet	
Dimension		Width	The Naked Eye	Follows Approval Data Sheet	
2		Length	The Naked Eye	Follows Approval Data Sheet	
		Overall	The Naked Eye	Follows Approval Data Sheet	





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### **KLT Package Solutions**

KLT Camera Module



Tray with Grid and Space



Complete with Lens Protection Film



Place Cameras on the Tray







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### **Camera Modules Package Solution**

**Full Tray of Cameras** 



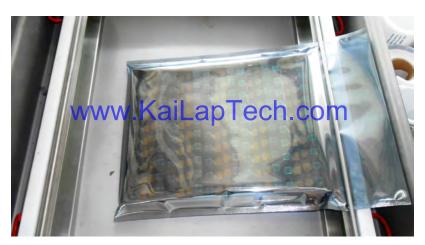
Put Tray into Anti-Static Bag



Cover Tray with Lid



Vacuum the Anti-Static Bag







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### **Camera Modules Package Solution**

**Sealed Vacuum Bag with Labels** 1. Model and Description 2. Quantity 3. Shipping Date 4. Caution







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### **Large Order Package Solution**

Place Foam Sheets Between Trays

Foam Sheets are Slightly Larger than Trays





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Place Foam Sheets and Trays into Box

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Foam Sheets are Tightly Fitting Box









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### **Small Order Package Solution**

Place Foam Sheets and Trays into Small Box

Foam Sheets are Nicely Fitting the Small Box



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Package in Small Box for Shipment



Place Small Boxes into Larger Box









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### **Carbon Box Package Solution**

Seal the Carbon Box

Final Package Labelled Box





1. Delivery Address and Phone No. 2. Box No. and Ship Date 3. Fragile Caution







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### **Sample Order Package Solution**

Place Sample into Small Anti-Static Bag

Place Connectors into Small Ant-Static Bag





Sample Labels on the Small Bag 1. Camera Module or Connector Model 2. Shipping Date and Quantity 3. Caution







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### **Connectors Large Order Package Solution**

Connectors in a Wheel







The Wheel is Perfectly Fitting the Box

Connectors Box Ready for Shipment









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#### Company Kai Lap Technologies (KLT)

Kai Lap Technologies Group Limited. (KLT) was established in 2009, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. KLT is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

KLT provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. KLT specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.





#### **Limited Warranty**

KLT provides the following limited warranty if you purchased the Product(s) directly from KLT company or from KLT's website, <a href="www.KaiLapTech.com">www.KaiLapTech.com</a>. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. KLT guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials of workmanship during the Warranty Reriod, KLT will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of KLT is solely limited to repair and/or replacement on the terms set forth above. KLT is not reliable or responsible for any subsequential events.

















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#### **KLT Strength**

#### **Powerful Factory**





#### **Professional Service**







#### **Promised Delivery**





